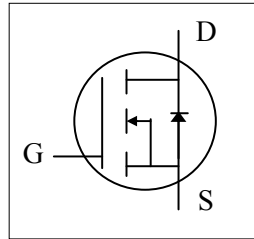
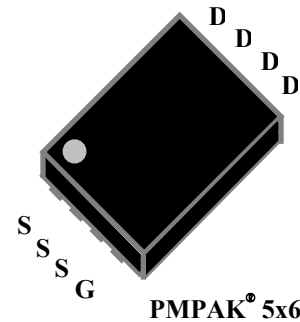




- ▼ 100% R_g & UIS Test
- ▼ Simple Drive Requirement
- ▼ Ultra Low On-resistance
- ▼ RoHS Compliant & Halogen-Free



BV _{DSS}	45V
R _{DS(ON)}	1.4mΩ



PMPAK[®] 5x6

Description

AP4NA1R4C series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The PMPAK[®] 5x6 package is special for DC-DC converters application and the foot print is compatible with SO-8 with backside heat sink and lower profile.

Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	45	V
V _{GS}	Gate-Source Voltage	+20	V
I _D @T _C =25°C	Drain Current, V _{GS} @ 10V ⁴ (Silicon Limited)	223	A
I _D @T _C =25°C	Drain Current, V _{GS} @ 10V ⁴	100	A
I _D @T _A =25°C	Drain Current, V _{GS} @ 10V ³	49	A
I _D @T _A =70°C	Drain Current, V _{GS} @ 10V ³	39	A
I _{DM}	Pulsed Drain Current ¹	400	A
P _D @T _C =25°C	Total Power Dissipation	104	W
P _D @T _A =25°C	Total Power Dissipation ³	5	W
E _{AS}	Single Pulse Avalanche Energy ⁵	125	mJ
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R _{thj-c}	Maximum Thermal Resistance, Junction-case	1.2	°C/W
R _{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	25	°C/W



AP4NA1R4CMT-A

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	45	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=20A$	-	-	1.4	mΩ
		$V_{GS}=4.5V, I_D=20A$	-	-	2.5	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{DS}=5V, I_D=20A$	-	110	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=36V, V_{GS}=0V$	-	-	10	uA
I_{GSS}	Gate-Source Leakage	$V_{GS}=20V, V_{DS}=0V$	-	-	100	nA
Q_g	Total Gate Charge	$I_D=20A$	-	47	75.2	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=20V$	-	12	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	23	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=20V$	-	14	-	ns
t_r	Rise Time	$I_D=20A$	-	42	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=1\Omega$	-	42	-	ns
t_f	Fall Time	$V_{GS}=10V$	-	11	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	4500	7200	pF
C_{oss}	Output Capacitance	$V_{DS}=20V$	-	1800	-	pF
C_{riss}	Reverse Transfer Capacitance	$f=1.0MHz$	-	150	-	pF
R_g	Gate Resistance	$f=1.0MHz$	-	1	2	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=20A, V_{GS}=0V$	-	-	1.3	V
t_{rr}	Reverse Recovery Time	$I_S=20A, V_{GS}=0V,$	-	48	-	ns
Q_{rr}	Reverse Recovery Charge	$di/dt=100A/\mu s$	-	45	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board, $t \leq 10sec$; 60°C/W at steady state.
- 4.Package limitation current is 100A .
- 5.Starting $T_j=25^\circ C$, $V_{DD}=30V$, $L=0.1mH$, $R_G=25\Omega$

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT, AUTOMOTIVE OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

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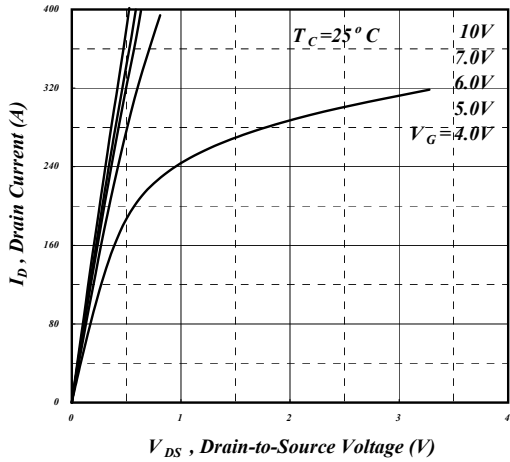


Fig 1. Typical Output Characteristics

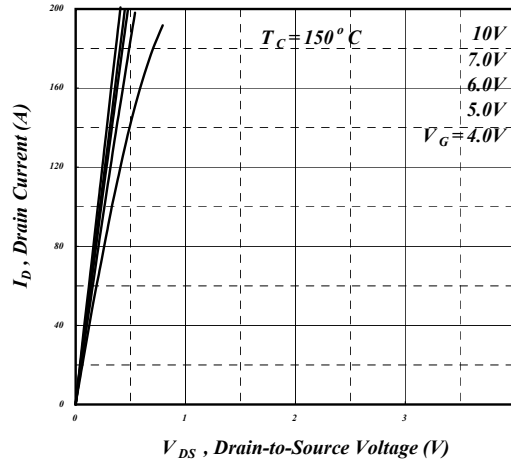


Fig 2. Typical Output Characteristics

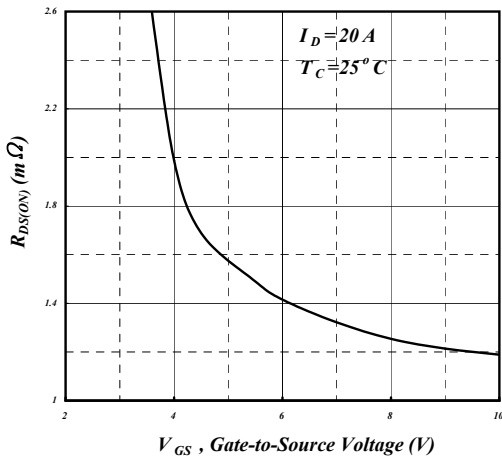


Fig 3. On-Resistance v.s. Gate Voltage

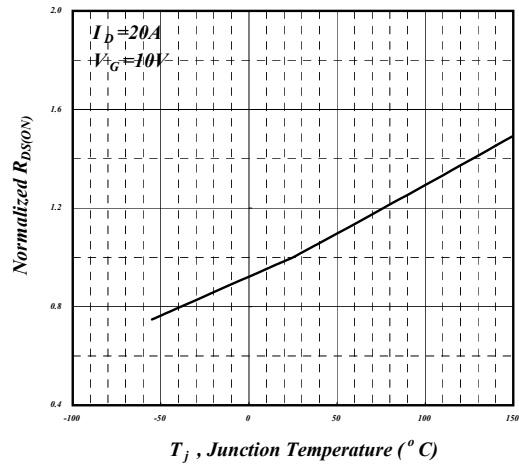


Fig 4. Normalized On-Resistance v.s. Junction Temperature

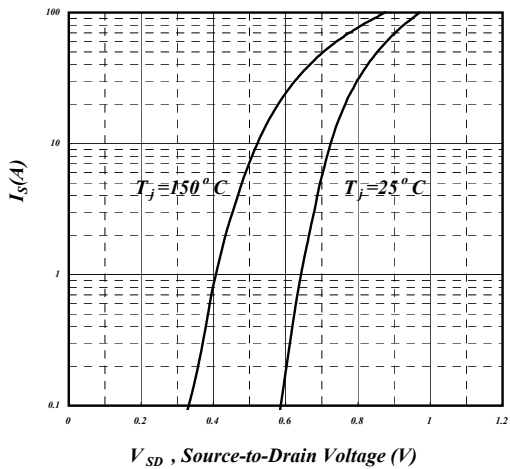


Fig 5. Forward Characteristic of Reverse Diode

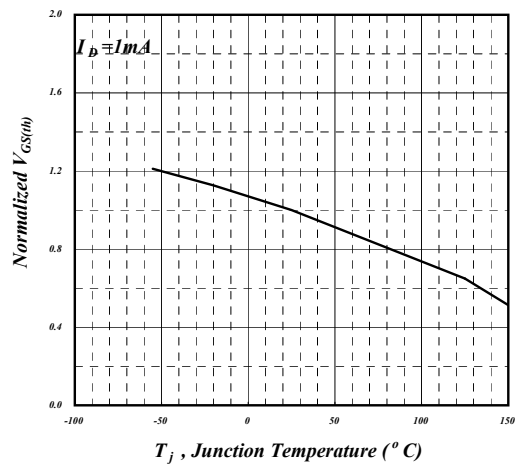


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



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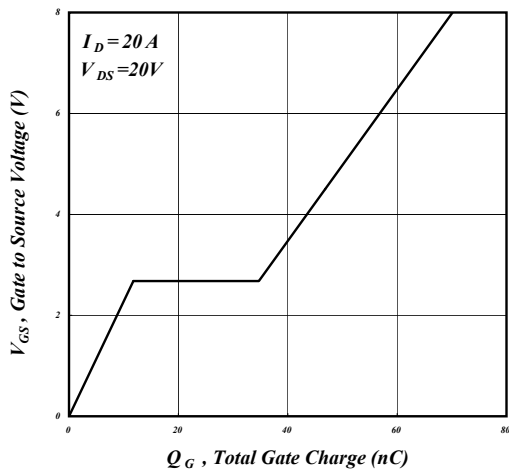


Fig 7. Gate Charge Characteristics

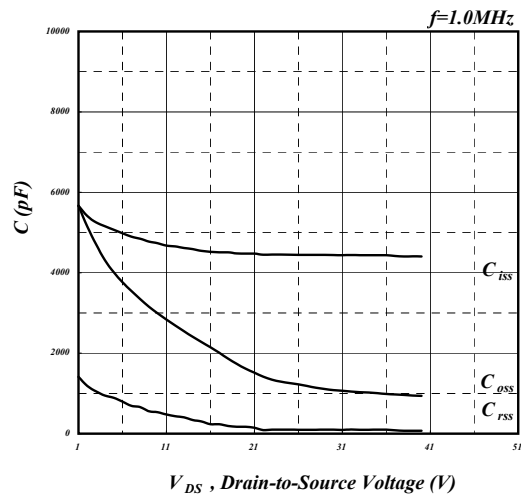


Fig 8. Typical Capacitance Characteristics

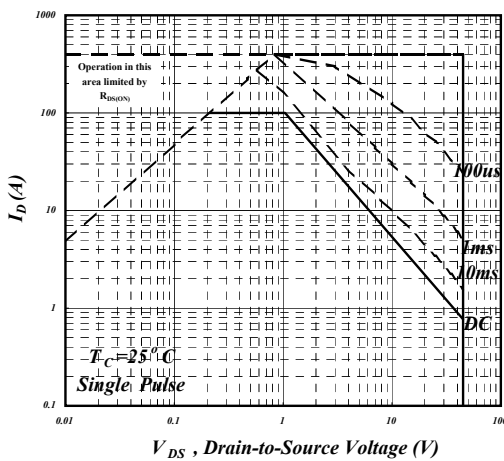


Fig 9. Maximum Safe Operating Area

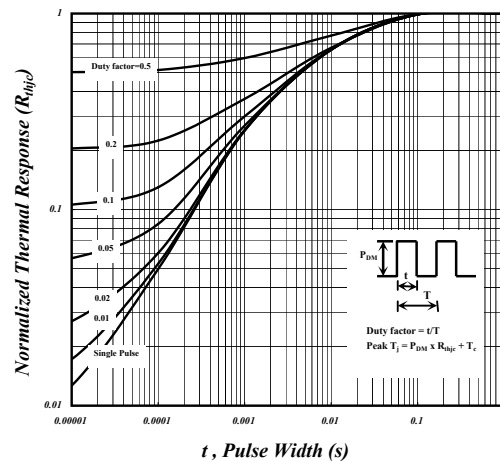


Fig 10. Effective Transient Thermal Impedance

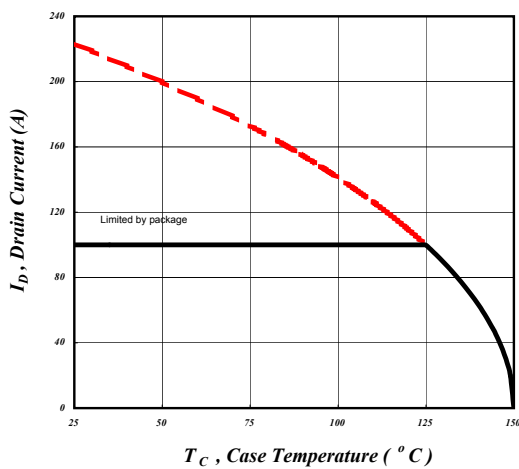


Fig 11. Drain Current v.s. Case Temperature

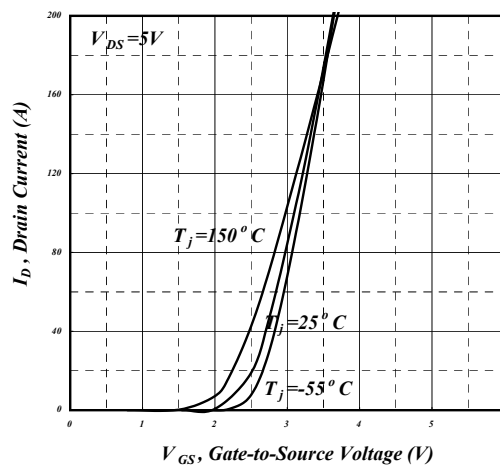


Fig 12. Transfer Characteristics

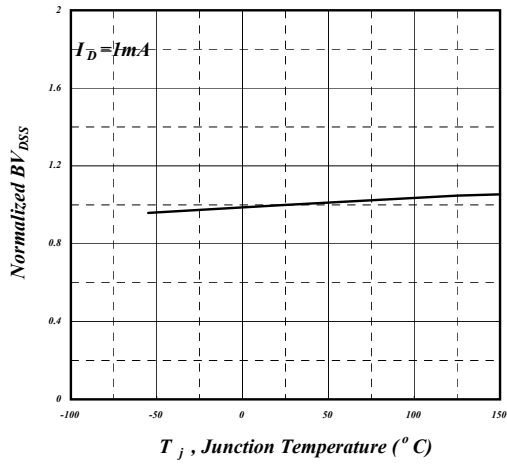


Fig 13. Normalized BV_{DSS} v.s. Junction Temperature

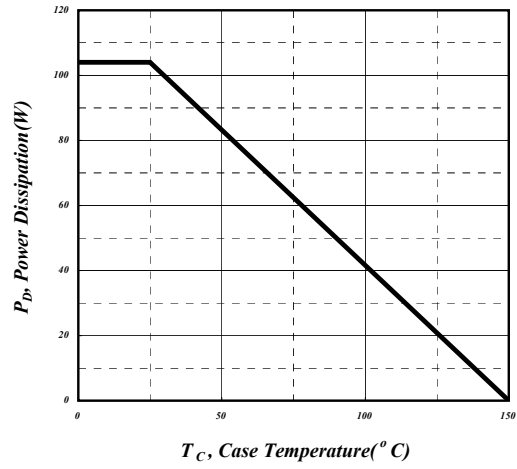


Fig 14. Total Power Dissipation

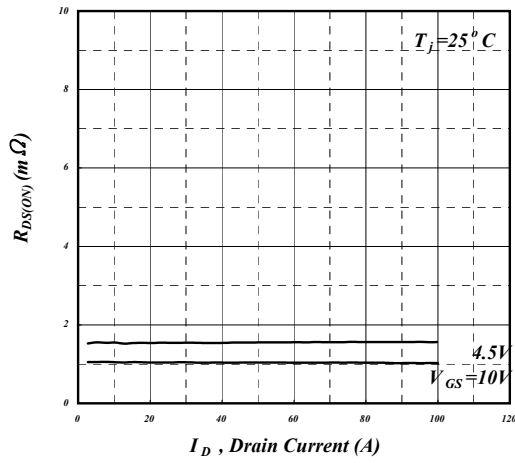
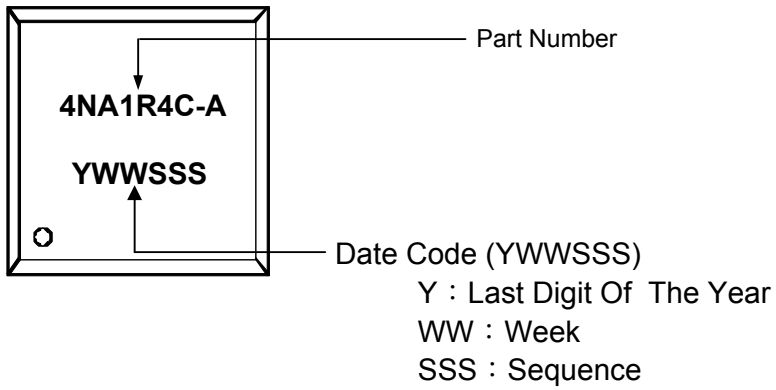


Fig 15. Typ. Drain-Source on State Resistance



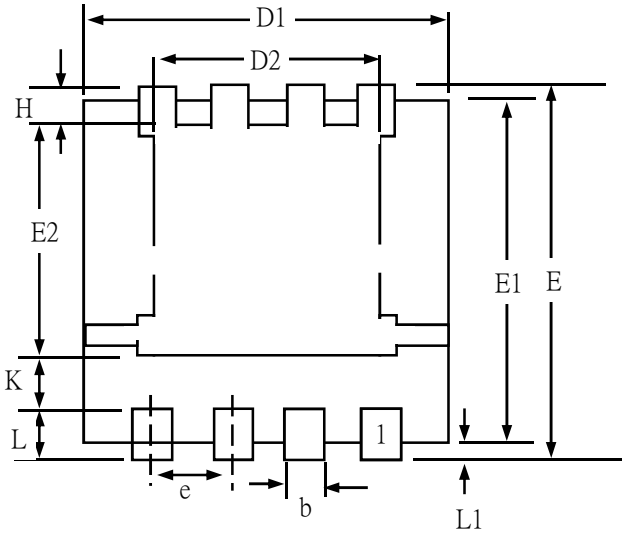
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MARKING INFORMATION

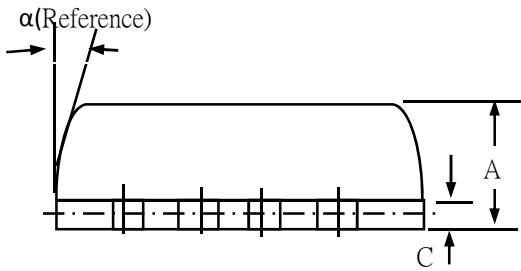




Package Outline : PMPAK 5x6



BACKSIDE VIEW

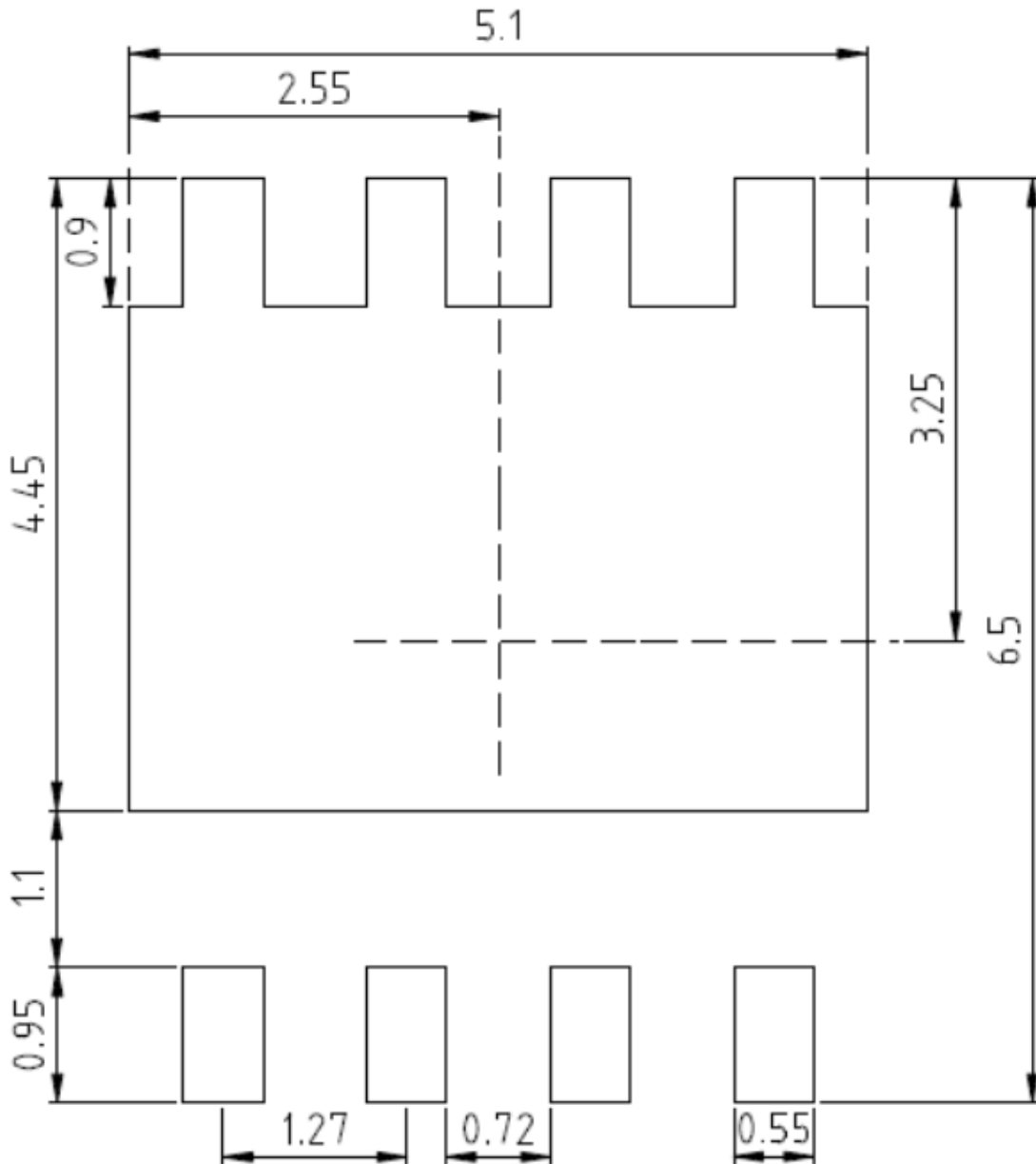


SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	0.90	1.10	1.30
b	0.33	0.41	0.51
C	0.254(Ref.)		
D1	4.80	4.90	5.10
D2	3.61	4.00	4.40
E	5.80	6.00	6.20
E1 (Ref.)	5.60	5.75	5.90
E2 (Ref.)	3.30	3.55	3.80
e	1.27 BSC		
H	0.35	—	0.90
K (Ref.)	1.00	1.275	—
L	0.35	0.55	0.75
L1	0.06	0.13	0.20
alpha(Ref.)	0°	—	12°

- 1.All Dimension Are In Millimeters.
- 2.Dimension Does Not Include Mold Protrusions.



PMPAK 5X6(E-TYPE) FOOTPRINT :



UNIT: mm